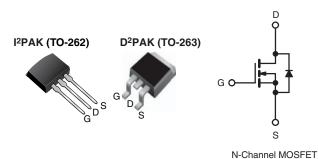


www.vishay.com

Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	60			
R _{DS(on)} (Ω)	V _{GS} = 10 V	0.018		
Q _g (Max.) (nC)	110			
Q _{gs} (nC)	29			
Q _{gd} (nC)	36			
Configuration	Single			



FEATURES

- Advanced process technology
- Surface mount (IRFZ48S, SiHFZ48S)
- Low-profile through-hole (IRFZ48L, SiHFZ48L)
- 175 °C operating temperature
- Fast switching
- Material categorization: for definitions of compliance please www.vishay.com/doc?99912



Note

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details.

DESCRIPTION

Third generation power MOSFETs from Vishay utilize advanced processing techniques to achieve extremely low on-resistance per silicon area. This benefit, combined with the fast switching speed and ruggedized device design that Power MOSFETs are well known for, provides the designer with an extremely efficient and reliable device for use in a wide variety of applications.

The D2PAK is a surface mount power package capable of accommodating die sizes up to HEX-4. It provides the highest power capability and the lowest possible on-resistance in any existing surface mount package. The D²PAK is suitable for high current applications because of its low internal connection resistance and can dissipate up to 2 W in a typical surface mount application.

The through-hole version (IRFZ48L, SiHFZ48L) is available for low-profile applications.

ORDERING INFORMATION				
Package	D ² PAK (TO-263)	I ² PAK (TO-262)		
Lead (Pb)-free and halogen-free	SiHFZ48S-GE3	SiHFZ48L-GE3		
Lead (Pb)-free	IRFZ48SPbF	-		

Note

a. See device orientation.

ABSOLUTE MAXIMUM RATINGS (TC	20 0, 0	1000 011101 1111	· · · · · · · · · · · · · · · · · · ·			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V_{DS}	60	V	
Gate-Source Voltage			V_{GS}	± 20	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	
Continuous Drain Current f	\/ at 10 \/	V_{GS} at 10 V $T_{C} = 25 ^{\circ}C$ $T_{C} = 100 ^{\circ}C$	I _D	50		
Continuous Drain Current	V _{GS} at 10 V			50	Α	
Pulsed Drain Current ^{a, e}			I _{DM}	290		
Linear Derating Factor				1.3	W/°C	
Single Pulse Avalanche Energy b, e			E _{AS}	100	mJ	
Marian and Danier Distriction	T _C =	25 °C	Б	190	10/	
Maximum Power Dissipation	T _A = 25 °C		P_{D}	3.7	W	
Peak Diode Recovery dV/dt c, e			dV/dt	4.5	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +175	00	
Soldering Recommendations (Peak temperature) d	for	10 s		300	°C	

- Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). $V_{DD}=25$ V, Starting $T_J=25$ °C, L = 22 μ H, $R_g=25$ Ω , $I_{AS}=72$ A (see fig. 12). $I_{SD}\leq72$ A, $dI/dt\leq200$ A/ μ s, $V_{DD}\leq V_{DS}$, $T_J\leq175$ °C. 1.6 mm from case.

- Uses IRFZ48, SiHFZ48 data and test conditions.
- Calculated continuous current based on maximum allowable junction temperature.



IRFZ48S, IRFZ48L, SiHFZ48S, SiHFZ48L

Vishay Siliconix

www.vishay.com

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient (PCB mount) ^a	R _{thJA}	-	40	°C/W	
Maximum Junction-to-Case (Drain)	R _{thJC}	-	0.8		

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		<u> </u>			•		
Drain-Source Breakdown Voltage	V _{DS}	V _{GS}	= 0, I _D = 250 μA	60	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 1 mA ^c	-	0.060	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 20 V	-	-	± 100	nA
Zoro Coto Voltago Drain Current	1	V _{DS}	= 60 V, V _{GS} = 0 V	-	-	25	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 48 V	, V _{GS} = 0 V, T _J = 150 °C	-	-	250	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 43 A ^b	-	-	0.018	Ω
Forward Transconductance	9 _{fs}	V _{DS} =	= 25 V, I _D = 43 A ^b	27	-	-	S
Dynamic							
Input Capacitance	C _{iss}	$V_{GS} = 0 V$,		-	2400	-	
Output Capacitance	C _{oss}		$V_{DS} = 25 \text{ V},$	-	1300	-	рF
Reverse Transfer Capacitance	C _{rss}	f = 1.	0 MHz, see fig. 5 ^c	-	190	-	
Total Gate Charge	Qg		. 70 4 1/ 40 1/	-	-	110	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 \text{ V}$ $I_D = 72 \text{ A}, V_{DS} = 48 \text{ V},$ see fig. 6 and 13 b, c		-	-	29	nC
Gate-Drain Charge	Q _{gd}		See lig. 6 and 16	-	-	36	1
Turn-On Delay Time	t _{d(on)}		•	-	8.1	-	
Rise Time	t _r	V _{DD} = 30 V, I _D = 72 A,		-	250	-	1
Turn-Off Delay Time	t _{d(off)}		$t_D = 0.34 \Omega$, see fig. 10 b, c	-	210	-	ns -
Fall Time	t _f			-	250	-	
Internal Source Inductance	L _S	Between lead	, and center of die contact	-	7.5	-	nΗ
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET sym showing the		-	-	50°	
Pulsed Diode Forward Current ^a	I _{SM}	integral reverse p - n junction diode		-	-	290	- A
Body Diode Voltage	V _{SD}	T _J = 25 °C	, I _S = 72 A, V _{GS} = 0 V ^b	-	-	2.0	V
Body Diode Reverse Recovery Time	t _{rr}			-	120	180	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$T_J = 25 ^{\circ}\text{C}, I_F = 72 \text{A}, dI/dt = 100 \text{A/µs}^{ \text{b, c}}$		-	500	800	μC
Forward Turn-On Time	t _{on}	Intrinsic tu	rn-on time is negligible (turn	on is dor	ninated b	v L _S and	L _D)

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width \leq 300 μ s; duty cycle \leq 2 %.
- c. Uses IRFZ48/SiHFZ48 data and test conditions.
- d. Calculated continuous current based on maximum allowable junction temperature.

www.vishay.com

Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

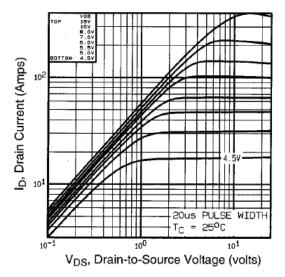


Fig. 1 - Typical Output Characteristics

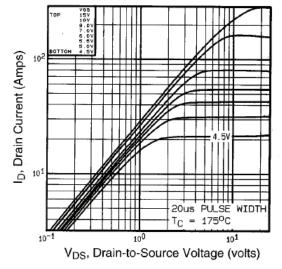


Fig. 2 - Typical Output Characteristics

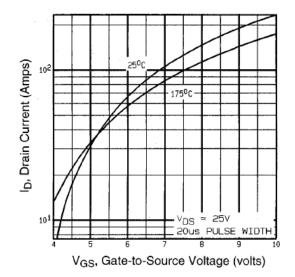


Fig. 3 - Typical Transfer Characteristics

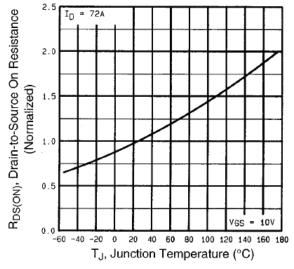


Fig. 4 - Normalized On-Resistance vs. Temperature

www.vishay.com

Vishay Siliconix

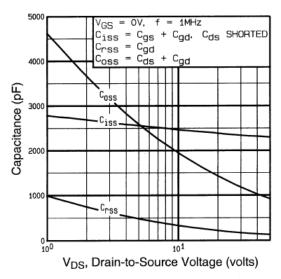


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

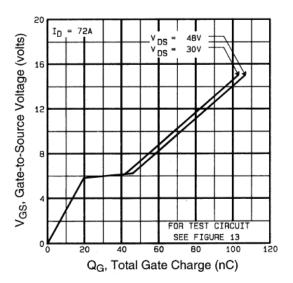


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

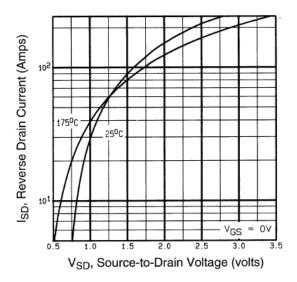


Fig. 7 - Typical Source-Drain Diode Forward Voltage

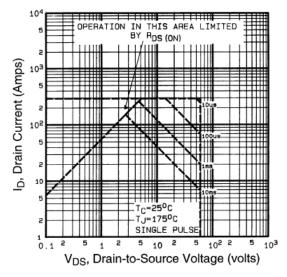


Fig. 8 - Maximum Safe Operating Area

Vishay Siliconix

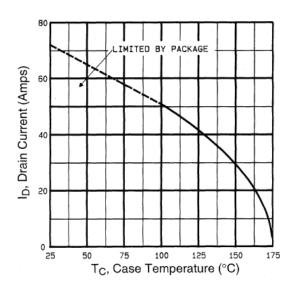


Fig. 9 - Maximum Drain Current vs. Case Temperature

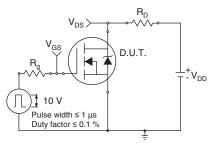


Fig. 10a - Switching Time Test Circuit

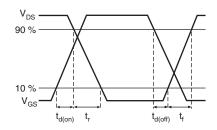
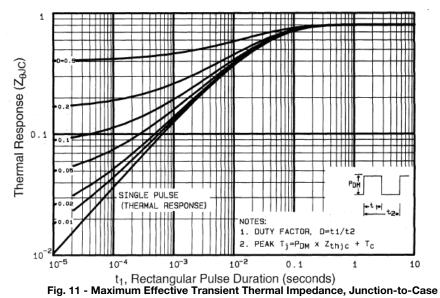


Fig. 10b - Switching Time Waveform



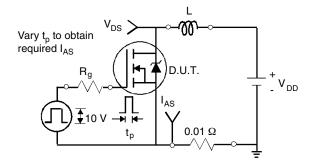


Fig. 12a - Unclamped Inductive Test Circuit

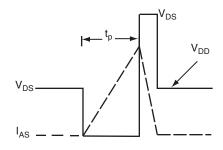


Fig. 12b - Unclamped Inductive Waveforms

Vishay Siliconix

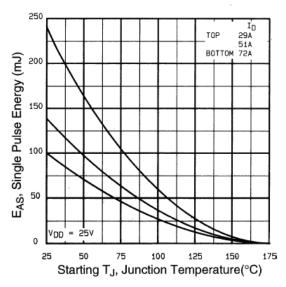


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

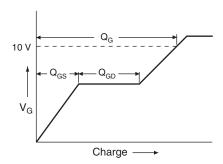


Fig. 13a - Maximum Avalanche Energy vs. Drain Current

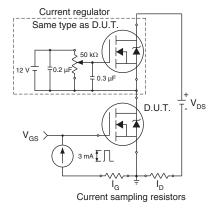
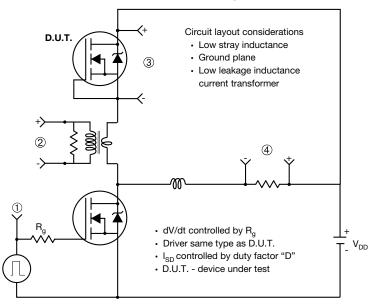


Fig. 13b - Gate Charge Test Circuit

Vishay Siliconix

Peak Diode Recovery dV/dt Test Circuit



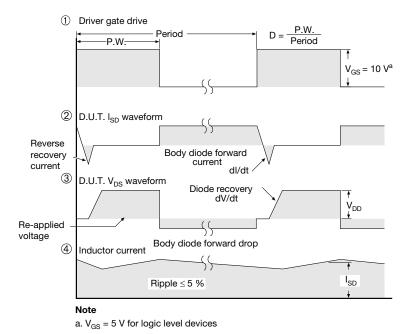


Fig. 14 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?90377.





TO-263AB (HIGH VOLTAGE)







	MILLIN	METERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
Α	4.06	4.83	0.160	0.190
A1	0.00	0.25	0.000	0.010
b	0.51	0.99	0.020	0.039
b1	0.51	0.89	0.020	0.035
b2	1.14	1.78	0.045	0.070
b3	1.14	1.73	0.045	0.068
С	0.38	0.74	0.015	0.029
c1	0.38	0.58	0.015	0.023
c2	1.14	1.65	0.045	0.065
D	8.38	9.65	0.330	0.380

	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
D1	6.86	-	0.270	-
Е	9.65	10.67	0.380	0.420
E1	6.22	-	0.245	ı
е	2.54	BSC	0.100 BSC	
Н	14.61	15.88	0.575	0.625
L	1.78	2.79	0.070	0.110
L1	-	1.65	ı	0.066
L2	-	1.78	-	0.070
L3	0.25	BSC	0.010	BSC
L4	4.78	5.28	0.188	0.208

ECN: S-82110-Rev. A, 15-Sep-08

DWG: 5970

Notes

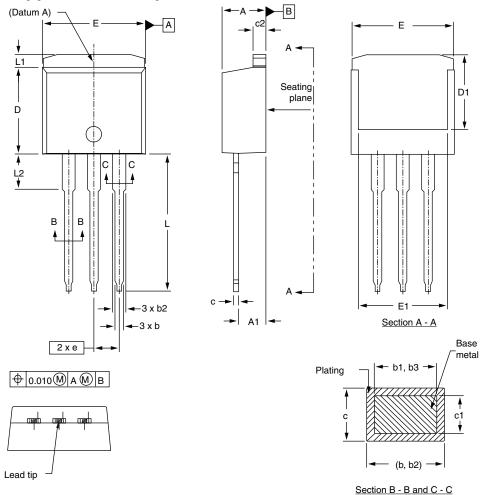
- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimensions are shown in millimeters (inches).
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.
- 4. Thermal PAD contour optional within dimension E, L1, D1 and E1.
- 5. Dimension b1 and c1 apply to base metal only.
- 6. Datum A and B to be determined at datum plane H.
- 7. Outline conforms to JEDEC outline to TO-263AB.

Document Number: 91364 www.vishay.com Revision: 15-Sep-08





I²PAK (TO-262) (HIGH VOLTAGE)



	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
Α	4.06	4.83	0.160	0.190
A1	2.03	3.02	0.080	0.119
b	0.51	0.99	0.020	0.039
b1	0.51	0.89	0.020	0.035
b2	1.14	1.78	0.045	0.070
b3	1.14	1.73	0.045	0.068
С	0.38	0.74	0.015	0.029
c1	0.38	0.58	0.015	0.023
c2	1.14	1.65	0.045	0.065

	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
D	8.38	9.65	0.330	0.380
D1	6.86	-	0.270	-
E	9.65	10.67	0.380	0.420
E1	6.22	-	0.245	-
е	2.54	BSC	SC 0.100 BSC	
L	13.46	14.10	0.530	0.555
L1	-	1.65	-	0.065
L2	3.56	3.71	0.140	0.146

Scale: None

ECN: S-82442-Rev. A, 27-Oct-08 DWG: 5977

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm per side. These dimensions are measured at the outmost extremes of the plastic body.
- 3. Thermal pad contour optional within dimension E, L1, D1, and E1.
- 4. Dimension b1 and c1 apply to base metal only.

Document Number: 91367 Revision: 27-Oct-08



Legal Disclaimer Notice

Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Revision: 13-Jun-16 1 Document Number: 91000

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Vishay:

IRFZ48S IRFZ48STRL IRFZ48SPBF